

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Wen-Jie QI, et al.

Serial No.: 10/023,328

Filed: December 20, 2001



Group Art Unit: 1765

Examiner: Lan Vinh

For: NITRIDE OFFSET SPACER TO MINIMIZE SILICON RECESS BY USING POLY REOXIDATION
LAYER AS ETCH STOP LAYER

Mail Stop

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

Transmitted herewith is an Amendment in the above-identified application.

- ☒ No additional fee is required.
☒ Applicant is entitled to small entity status under 37 CFR 1.27
☒ Also attached: Request for Approval of Drawing Amendment (Fig. 6A)

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	15	20	0	\$18.00 =	\$0.00
Independent Claims	2	3	0	\$84.00 =	\$0.00
Multiple claims newly presented					\$0.00
Fee for extension of time					\$0.00
Total of Above Calculations					\$0.00

- ☐ Please charge my Deposit Account No. 500417 in the amount of \$0.00. An additional copy of this transmittal sheet is submitted herewith.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 500417, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,

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Date: May 12, 2003

Docket No.: 50432-485

PATENT

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AMENDMENT

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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The following amendments and remarks are respectfully submitted in response to
the Office Action dated April 3, 2003.

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MAY 13 2003
TC 1700

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5/14/03
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